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POLL

EdXact signs distribution contract in Japan

[Anne-Francoise Pele](#)

[EE Times Europe](#)

02/05/2007 8:12 AM

PARIS – EdXact SA, an EDA startup company specializing in parametric extraction and physical verification, announced Monday (Feb. 5) it has appointed Marubeni Solutions Corporation (MSOL) as its exclusive distributor in Japan.

Under the terms of the agreement, MSOL will be in charge of technical support, marketing, and sales of parasitic data management & analysis tools from EdXact.

“In today’s nanometer designs, a strong demand is growing towards innovative technologies for accurate and fast backend analysis,” stated Yoshitsugu Itamiya, MSOL’s managing director, in a statement. “Dramatic performance enhancements are achieved with EdXact’s model order reduction technology, without any change in our customer’s existing flows. We feel a strong interest in this technology here in Japan.”

Founded in March 2004 in Grenoble, EdXact (Electronic Design eXtraction, Analysis, and Control Tools) claims it provides solutions that help to manage huge parasitic data files and to accelerate the overall backend physical verification cycle. While its Jivaro tools give electrical models of integrated circuits for accelerated simulation, its Comanche tool enables quick parasitic analysis, without the need to run extensive simulation.

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quantum mechanical explanation of Einstein's cosmological constant.



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DVB-T standard obsolete DVB-H?



[ST decides to import CMOS, change Crolles function](#)

STMicroelectronics NV, told analysts that ST would align with "industry leaders" to obtain a 32-nm CMOS process for use in its wafer fabs and as the basis for extensions.



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Veteran EDA analyst Gary Smith explains his "top ten" list of hot EDA topics for 2007, including electronic system level, design for manufacturability, IP reuse, analog/RF, globalization, and multicore SoC.



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Advanced Micro Devices and Hynix Semiconductor were set to break into the world's top 10 semiconductor suppliers in 2006, according to a preliminary ranking from market research analyst iSuppli Corp.

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